HMC348LP3

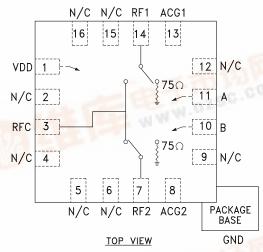
GaAs MMIC SPDT NON-REFLECTIVE CATV SWITCH, DC - 2.5 GHz

Typical Applications

The HMC348LP3 is ideal for:

- 75 Ohm Systems
 CATV Signal Distribution, Cable Modem
 Headend & DBS IF Switching
- 50 Ohm Systems
 Basestation Infrastructure & Test Equipment

Functional Diagram



Features

High Isolation: >80 dB @ 5 MHz (50 Ohm) >55 dB @ 1 GHz (50 Ohm)

"All Off" Isolation State

Non-Reflective Design, 75 Ohm Terminations

3 mm x 3 mm x 1 mm SMT Package

General Description

The HMC348LP3 is a non-reflective GaAs MESFET SPDT switch in a low cost leadless QFN surface mount plastic package ideal for CATV applications. Covering DC to 2.5 GHz, the switch offers high isolation, low insertion loss, integrated 75 Ohm terminations and an "all off" state. The switch features >80 dB isolation at 5 MHz and >55 dB isolation up to 1 GHz. The switch operates using complementary positive control voltage logic lines of +5/0V and requires a +5V bias supply (Vdd). This switch offers excellent performance in both 50 Ohm & 75 Ohm systems for either SPDT or SPST functions.

Electrical Specifications, T = +25° C, With 0/+5V Control, 50 Ohm System

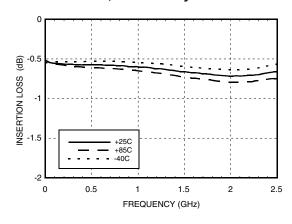
| Parameter | Frequency | Min. | Тур. | Max. | Units |
|--|---|----------------------------|----------------------------|------------|----------------------------|
| Insertion Loss | DC - 1000 MHz DC - 2500 MHz | | 0.6 0.7 | 0.9 1.0 | dB dB |
| Isolation | DC - 250 MHz DC - 750 MHz DC - 1000 MHz DC - 2000 MHz DC - 2500 MHz | 63 53 50 47 45 | 68 58 55 52 50 | DZSC | dB dB dB dB dB |
| Return Loss "On State" | DC - 2500 MHz | 15 | 20 | | dB |
| Return Loss RF1, RF2 "Off State" | DC - 1000 MHz DC - 2500 MHz | 9 | 12 11 | | dB dB |
| Input Power for 1 dB Compression | 50 MHz 1000 MHz | 20 25 | 23 28 | | dBm dBm |
| Input Third Order Intercept (Two-Tone Input Power= 0 dBm Each Tone, 6 MHz Tone Separation) | 50 MHz 1000 MHz 2500 MHz | | 43 48 51 | | dBm dBm dBm |
| Input Second Order Intercept (Two-Tone Input Power= 0 dBm Each Tone, 6 MHz Tone Separation) | 50 MHz 1000 MHz 2500 MHz | | 72 89 80 | | dBm dBm dBm |
| Switching Characteristics tRISE_tFALL (10/90% RF) ION, tOFF (50% CTL to 10/90% RF) | DC - 2500 MHz | | 25 600 | | ns ns |



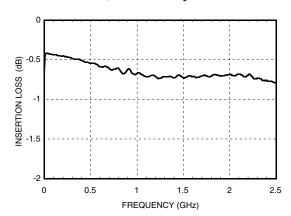


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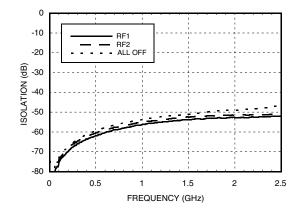
Insertion Loss, 50 Ohm System



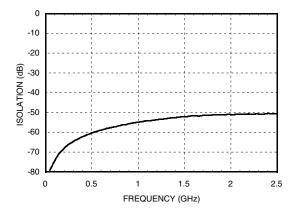
Insertion Loss, 75 Ohm System



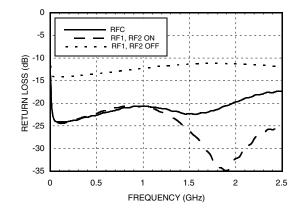
Isolation, 50 Ohm System



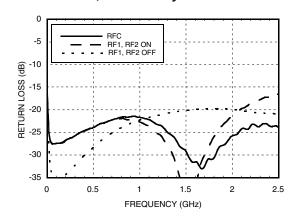
Isolation, 75 Ohm System



Return Loss, 50 Ohm System



Return Loss, 75 Ohm System

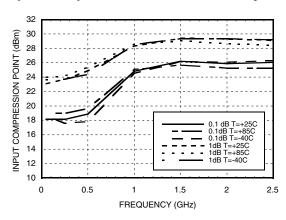


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GaAs MMIC SPDT NON-REFLECTIVE CATV SWITCH, DC - 2.5 GHz

Input Compression Point, 50 Ohm System



Absolute Maximum Ratings

| Bias Voltage Range (Vdd) | +7.0 Vdc |
|--|------------------------|
| RF Input Power | +30 dBm |
| Control Voltage Range (A & B) | +0.5V to Vdd + 1.0 Vdc |
| Channel Temperature | 150 °C |
| Continuous Pdiss (T = 85 °C) (derate 4 mW/°C above 85 °C) | 0.3 W |
| Thermal Resistance (Insertion Loss Path) | 104 °C/W |
| Thermal Resistance (Terminated Path) | 240 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |

Control Voltages

| State | Bias Condition |
|-------|----------------------------------|
| Low | 0 to +0.8V @ 5 uA Typical |
| High | +2.0 to +5.0 Vdc @ 35 uA Typical |

Bias Voltage & Current

| Vdd Range = +5.0 Vdc ±10% | | |
|---------------------------|--------------------|--------------------|
| Vdd (Vdc) | ldd (Typ.) (mA) | Idd (Max.) (mA) |
| +5.0 | 1.1 | 2.2 |

Truth Table

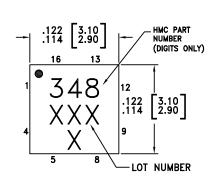
| Control Input | | Signal Path State | | |
|---------------|------|-------------------|------------|--|
| А | В | RFC to RF1 | RFC to RF2 | |
| High | Low | On | Off | |
| Low | High | Off | On | |
| Low | Low | Off | Off | |

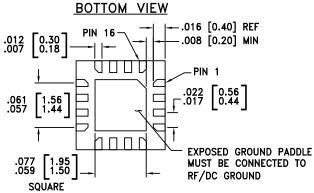
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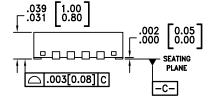


GaAs MMIC SPDT NON-REFLECTIVE CATV SWITCH, DC - 2.5 GHz

Outline Drawing







NOTES

- MATERIAL PACKAGE BODY: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEAD AND GROUND PADDLE MATERIAL: COPPER ALLOY
- 3. LEAD AND GROUND PADDLE PLATING: Sn/Pb SOLDER
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
 PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 7. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 8. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 9. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.

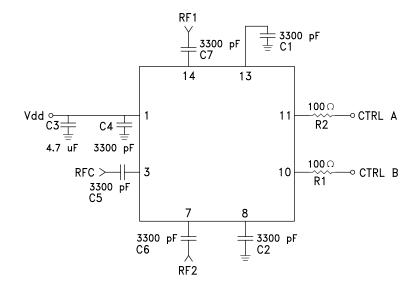
Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|--------------------------|---------------|---|---------------------|
| 1 | Vdd | Supply Voltage +5V ±10% | |
| 2, 4, 5, 6, 9, 12, 15,16 | N/C | These pins should be connected to PCB RF ground to maximize isolation. | |
| 3, 7, 14 | RFC, RF1, RF2 | These pins are DC coupled and matched to 75 Ohms. Blocking capacitors are required. | |
| 10 | В | See truth table and control voltage table. | 0 Vdd |
| 11 | А | See truth table and control voltage table. | 500 |
| 8, 13 | ACG1, ACG2 | External capacitors to ground are required. Select value for optimal isolation below 500 MHz. | |



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Application Circuit



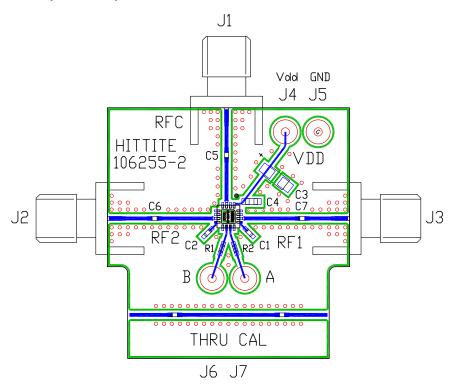
The value of capacitors C1 & C2 are critical for low frequency isolation performance below 500 MHz. 3300 pF 0402 size capacitors are recommended for optimal isolation down to 5 MHz. If the frequency of operation is above 500 MHz then 100 pF to 300 pF 0402 capacitors will be sufficient.

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GaAs MMIC SPDT NON-REFLECTIVE CATV SWITCH, DC - 2.5 GHz

Evaluation PCB (50 Ohms)



List of Material

| Item | Description | |
|---------------------------------------|------------------------------|--|
| J1 - J3 | PC Mount SMA RF Connector | |
| | | |
| J4 - J7 | DC Pin | |
| R1 - R2 | 100 Ohm Resistor, 0402 Pkg. | |
| C1, C2, C4 - C7 | 3300 pF Capacitor, 0402 Pkg. | |
| С3 | 4.7 uF Tantalum Capacitor | |
| U1 | HMC348LP3 SPDT Switch | |
| PCB* | 106255 Evaluation PCB | |
| * Circuit Board Material: Rogers 4350 | | |

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.